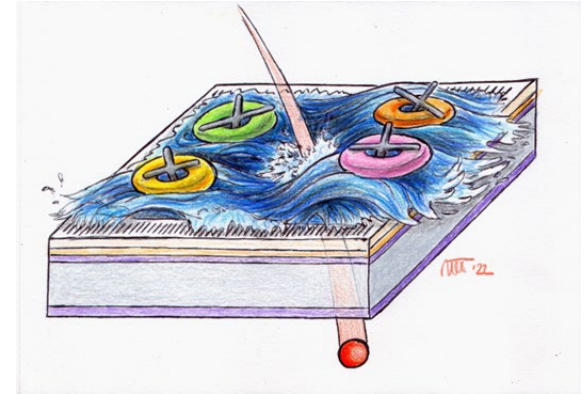




RSD2 performance in the AIDAINNOVA SPS test beam



LUCA MENZIO (INFN TORINO)

ON BEHALF OF THE AIDAINNOVA TESTBEAM TEAM

Contents

Introduction

- Resistive read-out in silicon detectors

Experimental Set-up

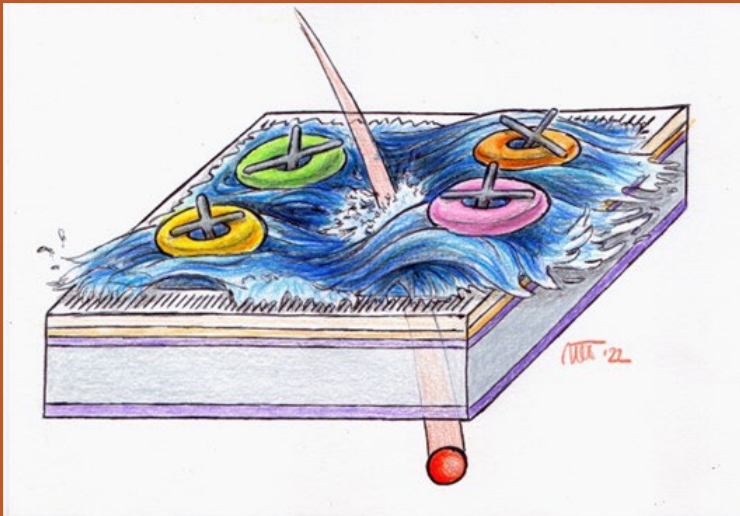
- AIDA test beam setup @ SPS
- Chubut2 acquisition board

Analysis and Results

- Analysis flow
- 1.3 mm-pitch sensor results
- 450 μm -pitch sensor characterization

Conclusions

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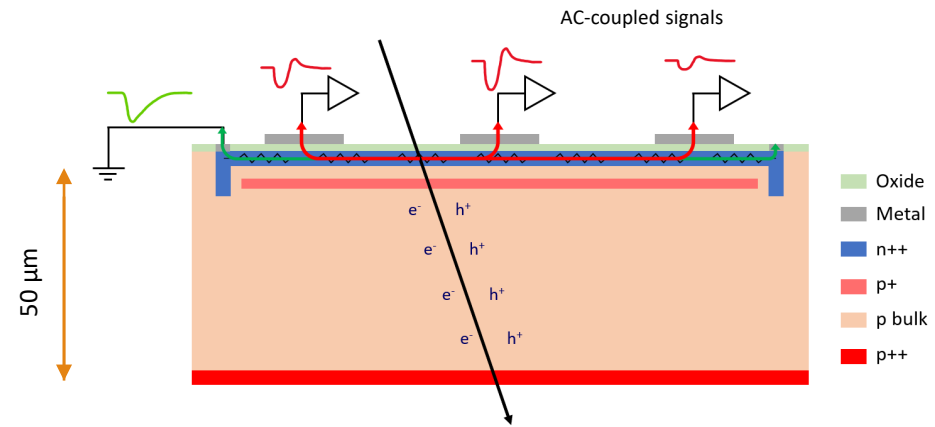
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Resistive Read-out

e-h pairs are produced by the impinging particle in the sensor volume



- Electrons are multiplied (LGAD)
- Charge is induced in the n+ layer (resistive layer)
- Nearby electrodes see a fast signal
- Charges in the n+ flow to ground **↳ Signal sharing**
- AC-coupled electrodes

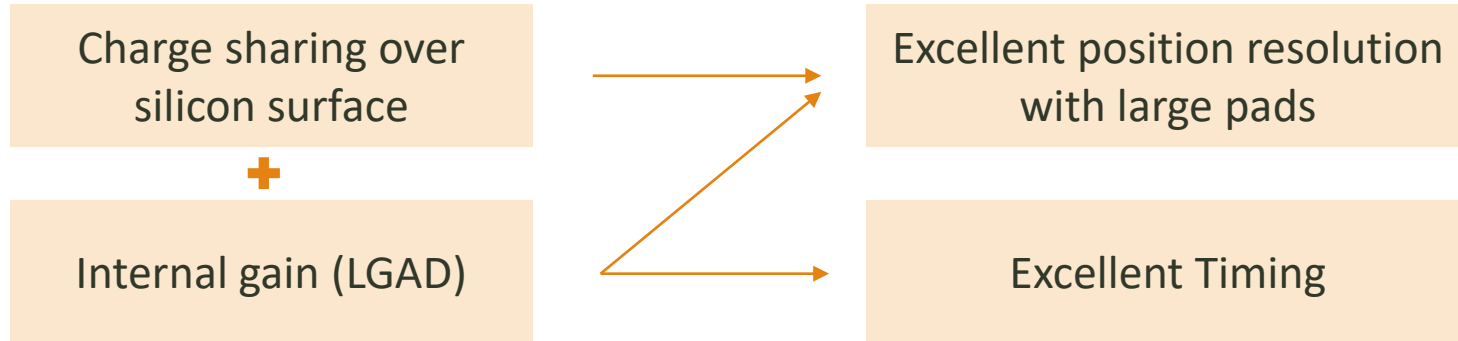
In normal pixel detectors $\sigma_x = k \frac{pitch}{\sqrt{12}}$ with $k \sim 0.5 - 1$
 Resistive read-out sensors have

- $\sigma_x \ll pitch$
- Time resolution typical of thin LGADs

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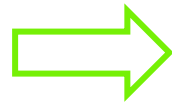
Resistive Read-out

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Pros

- Low channel density
- Low power consumption
- Thin sensors
- Low material budget



+ **100 %** intrinsic fill factor!

DUTs – RSD devices

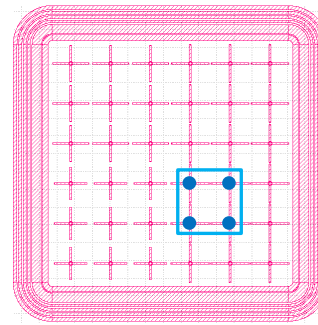
The DUTs come from the second production by FBK of Resistive Silicon Detectors (RSD2)

Two devices tested:

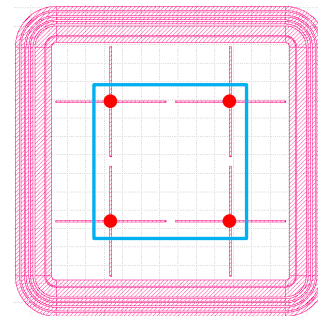
- 450x450 μm^2 from W7
- 1.3x1.3 μm^2 from W13

Same AC-electrodes layout – crosses to help the signal containment

Different n+ layer resistivity



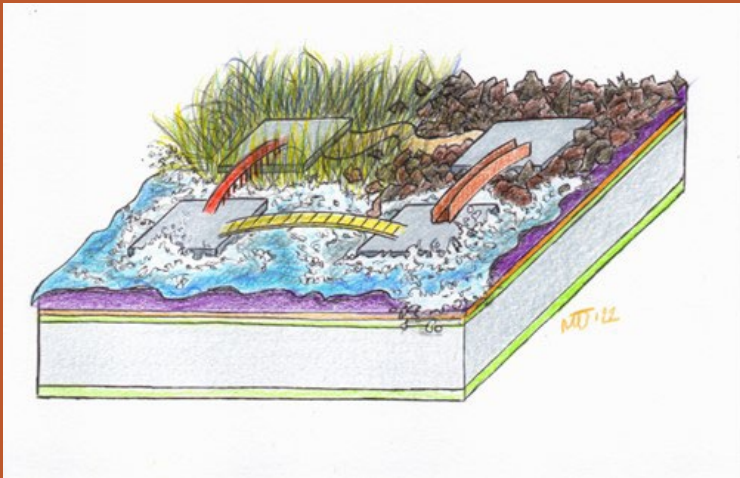
450 x 450 μm^2



1.3 x 1.3 mm²

Wafer #	Type	Carbon	n ⁺ dose	p gain dose
1	Si-Si 55 μm	N	A	0.96
2	Si-Si 55 μm	N	A	0.96
3	Si-Si 55 μm	N	A	0.98
4	Si-Si 55 μm	N	A	1
5	Si-Si 55 μm	N	A	1
6	Epi 45 μm	N	B	1
7	Si-Si 55 μm	N	B	0.98
8	Epi 45 μm	N	B	0.96
9	Epi 45 μm	N	B	0.96
10	Epi 45 μm	Y (1)	B	0.96
11	Epi 45 μm	N	C	0.96
12	Epi 45 μm	Y (0.8)	C	0.96
13	Si-Si 55 μm	N	C	0.98
14	Epi 45 μm	N	C	0.98
15	Si-Si 55 μm	N	C	0.94

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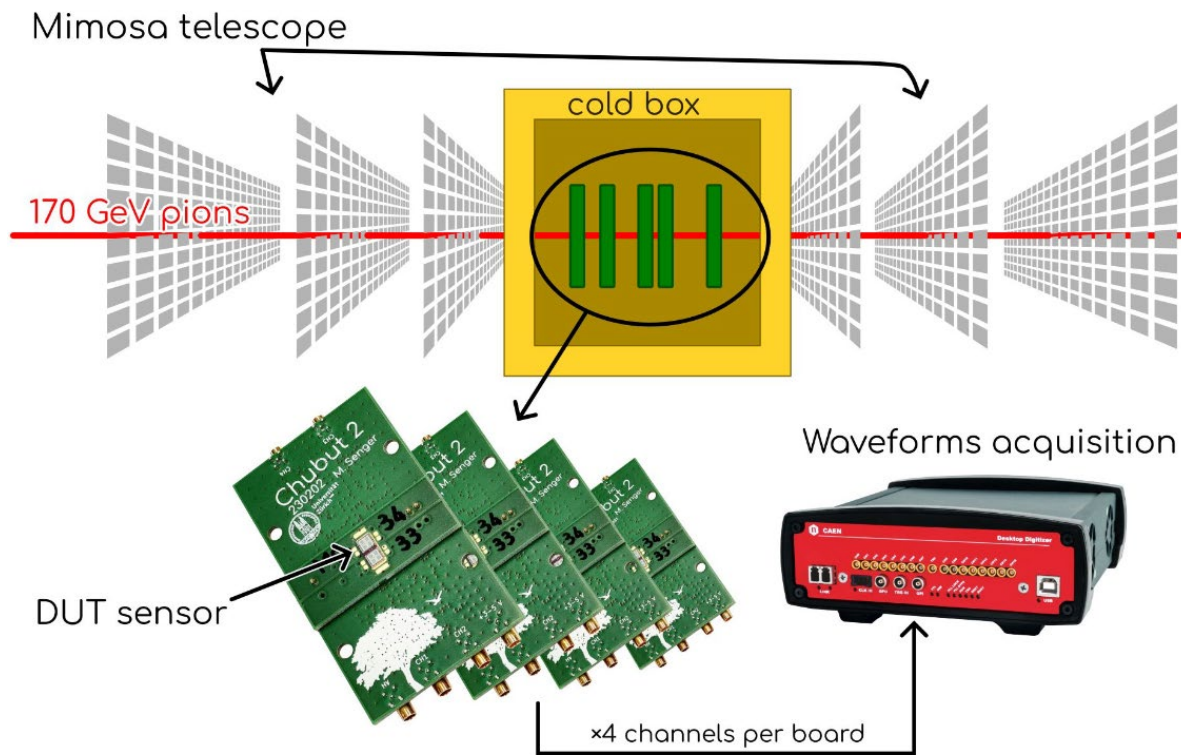
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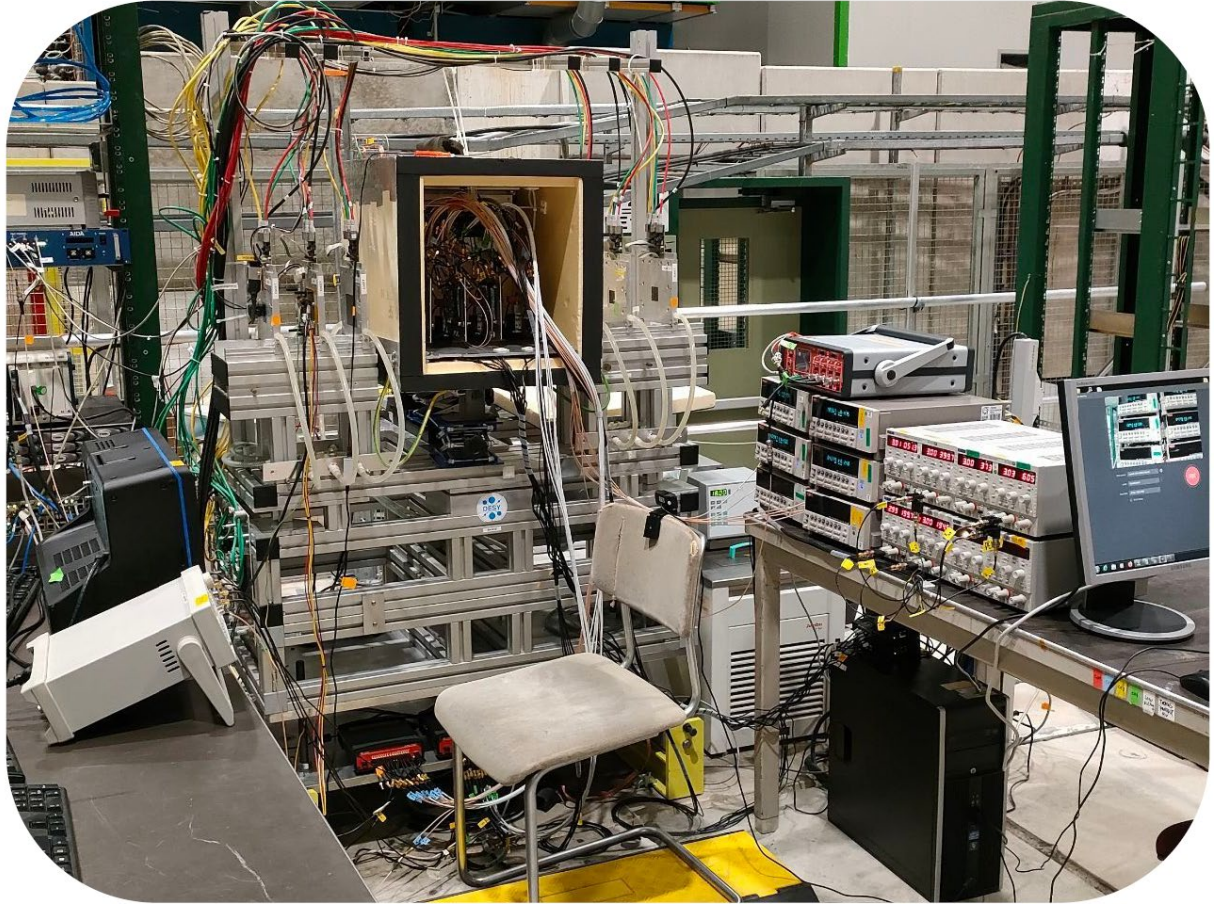
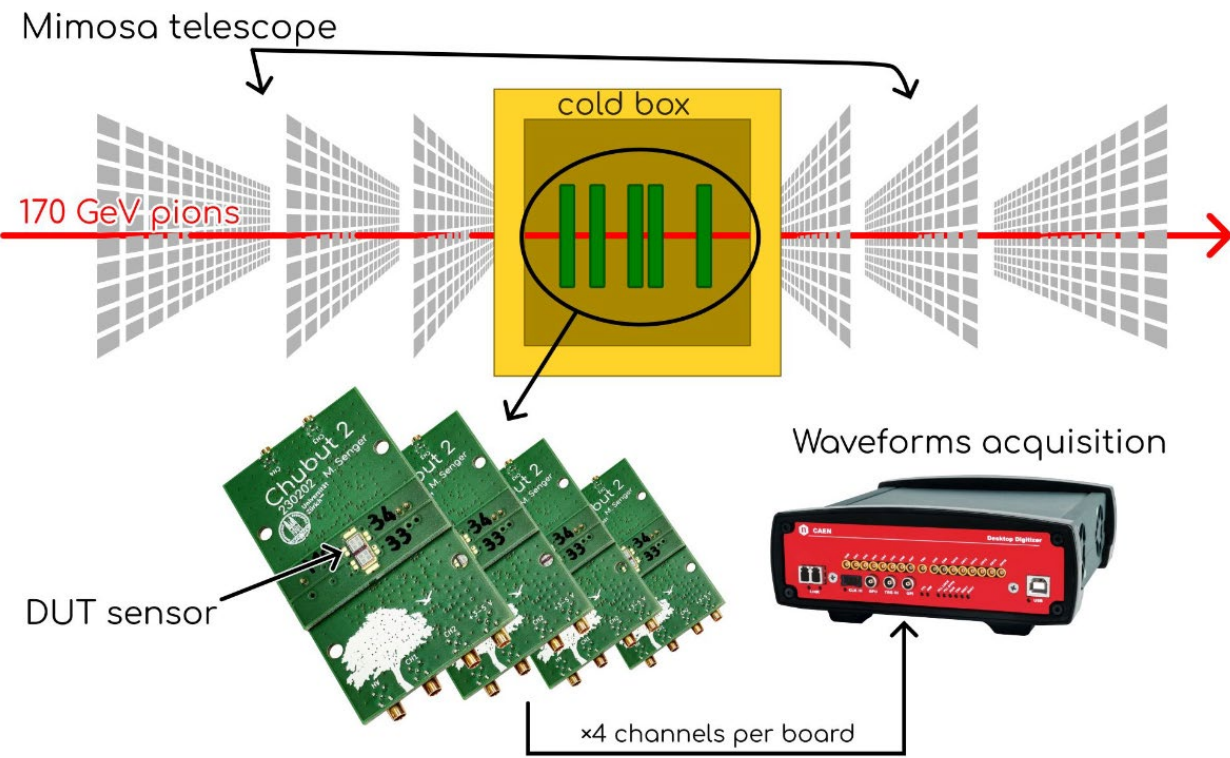
AIDA Test Beam



The test beam was performed in the CERN H6 beamline (120 GeV pions/protons)

- MIMOSA telescope
- CAEN DT5742 digitizer, 16 channels @ 5GS/s
- Trigger is a 3x3 mm² UFSD1 LGAD
- DUTs on the Chubut2 read-out board
- RSD runs:
 - 2 DUTs, 1.3 mm and 450 μm pitch biased at 240 V and 200 V, respectively
 - **No** time reference

AIDA Test Beam



Chubut2 Acquisition Board

The Chubut2 is a low-noise discrete readout board specifically developed for LGAD testing

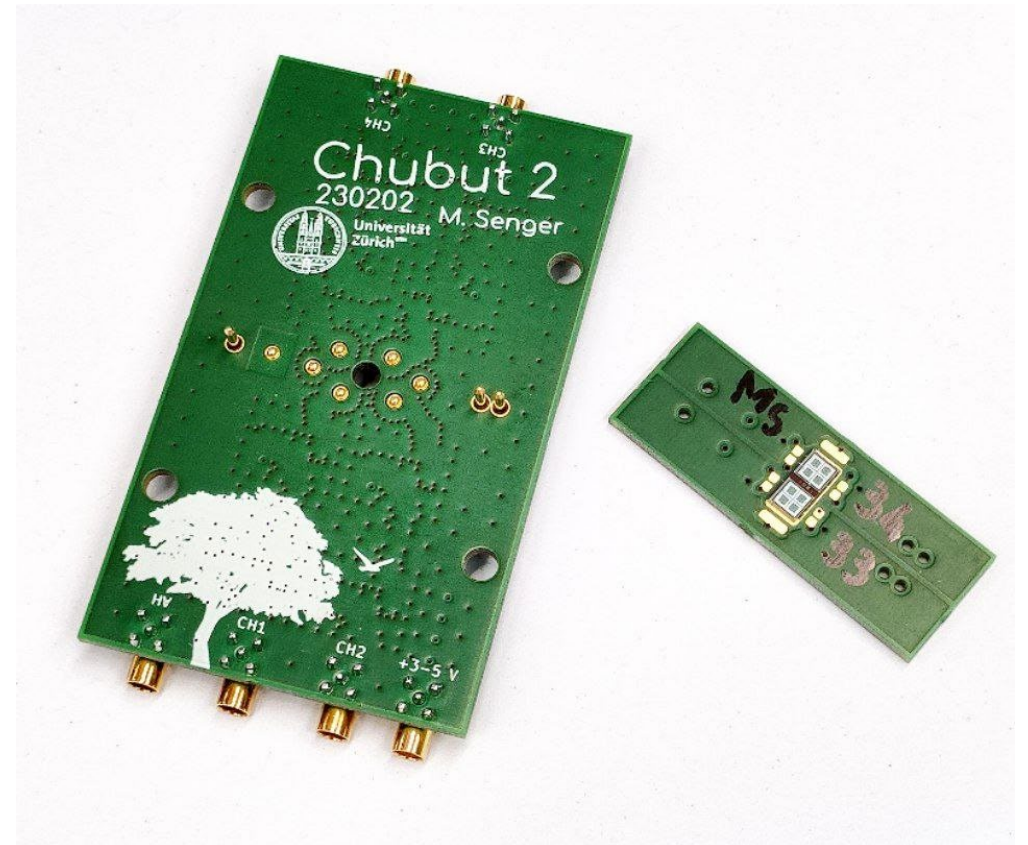
It features a

- Carrier boards that hosts the DUT
- Main board with amplification and power delivery circuitry

The design employed for this test beam has 4 identical channels, each with about 3540Ω transimpedance on 50Ω input and output

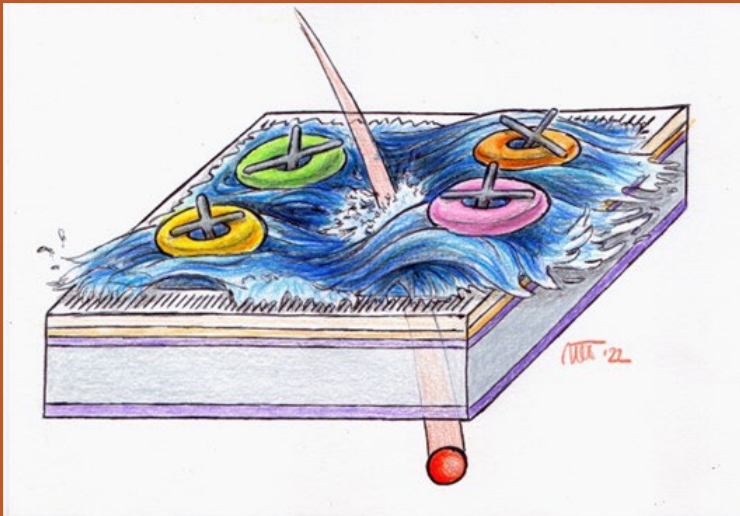
Good S/N with a budget friendly way of switching between sensors (one main board, multiple carrier boards)

Open source project¹



¹https://github.com/SengerM/Chubut_2?tab=readme-ov-file

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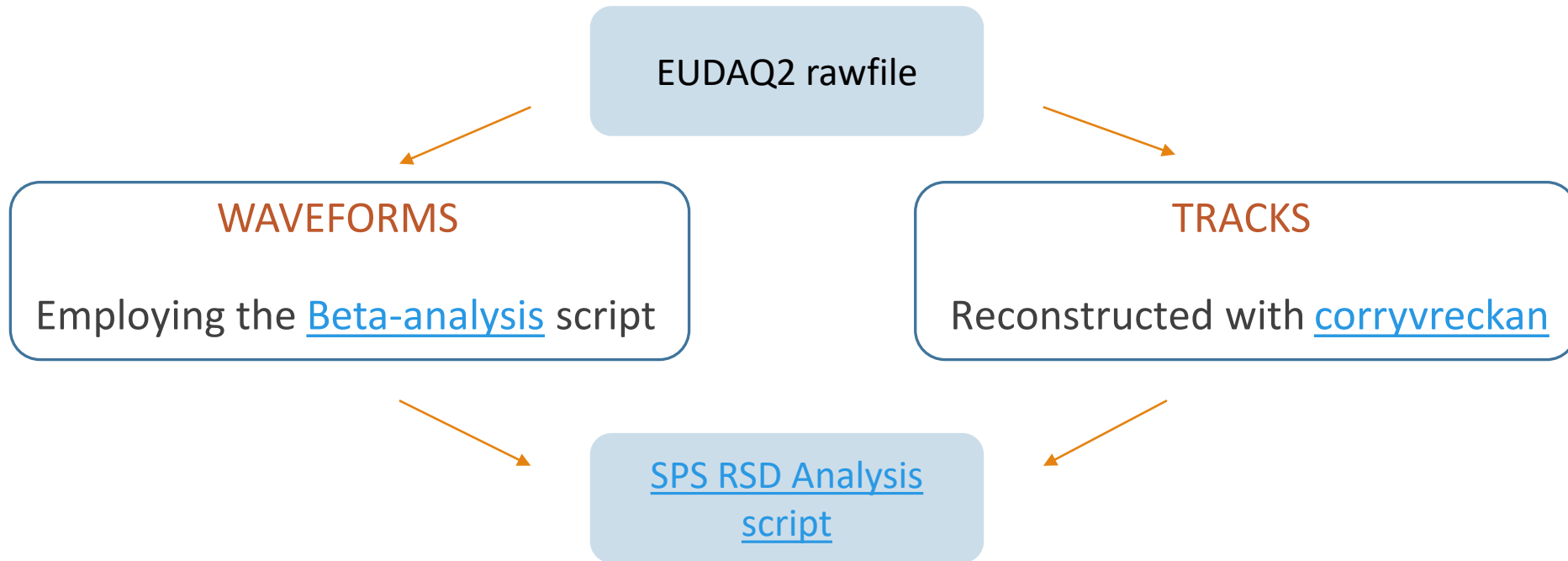
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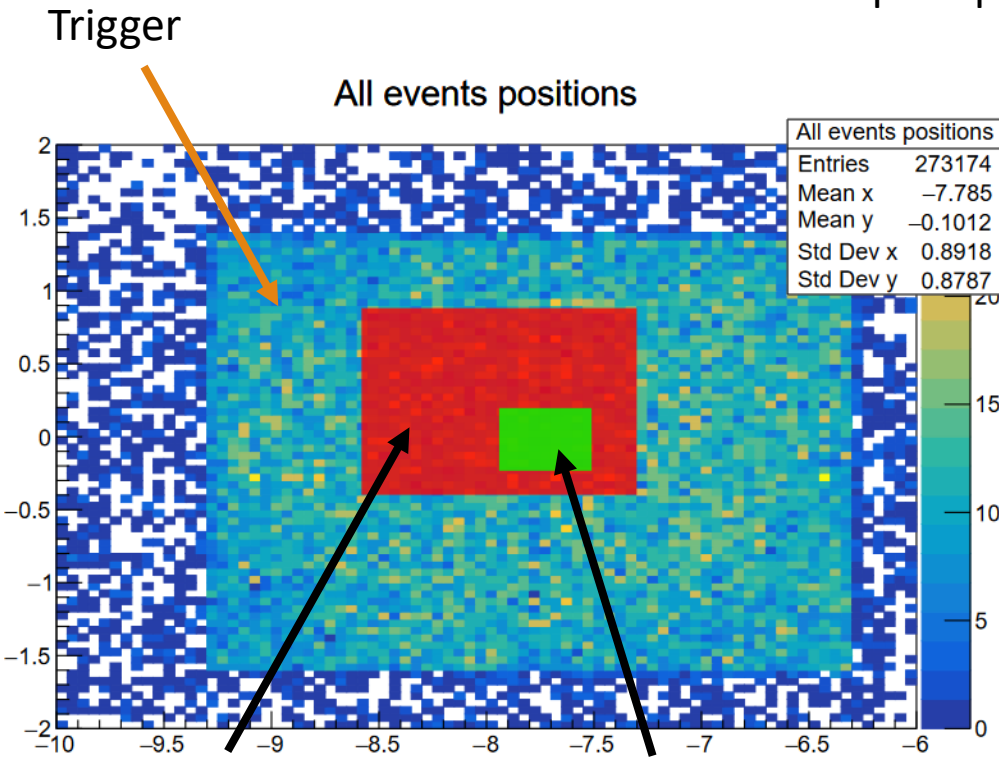
Waveforms and Tracks Analysis



Having a look at the sensors

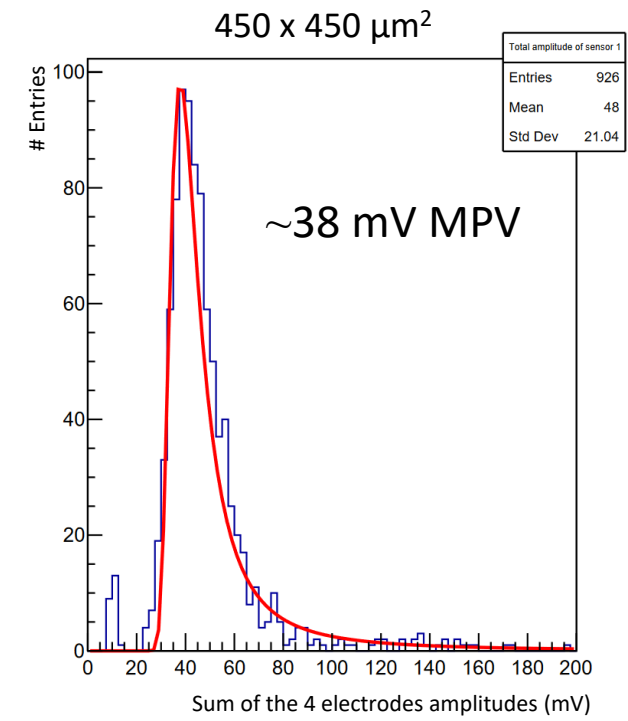
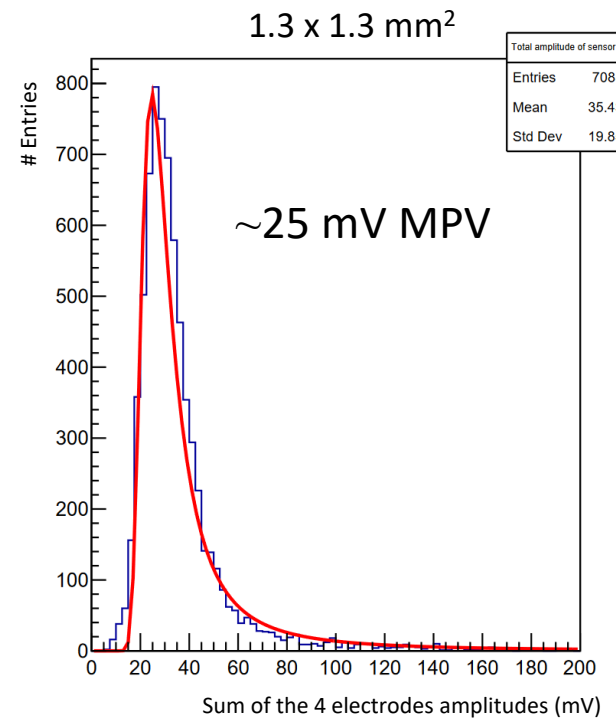
The sensors overlap in space and have good signals

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1.3 mm sensor

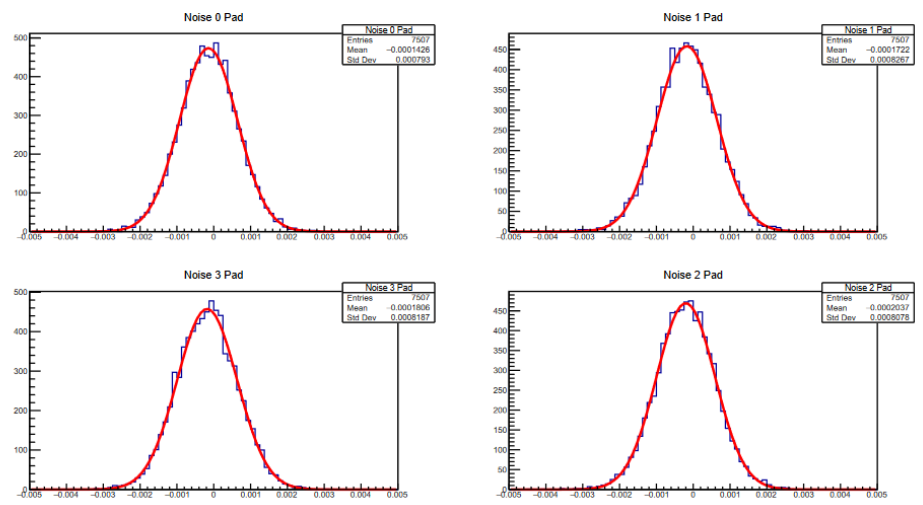
450 μm sensor



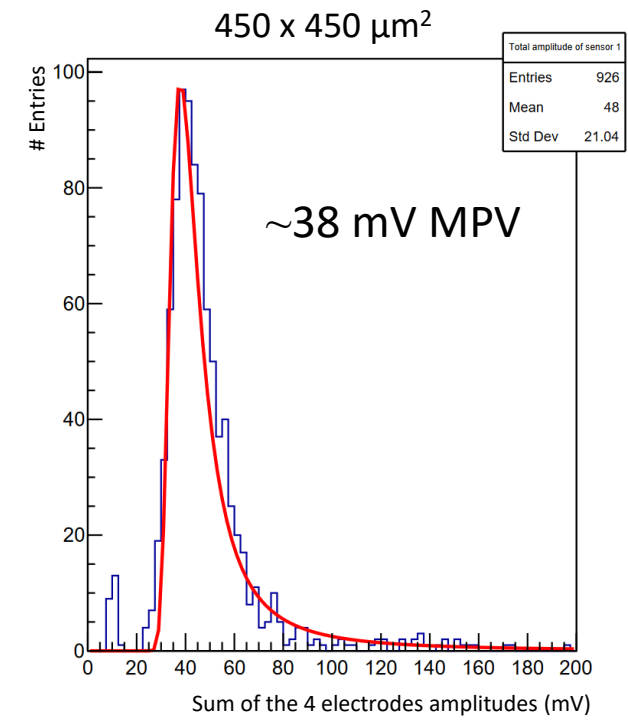
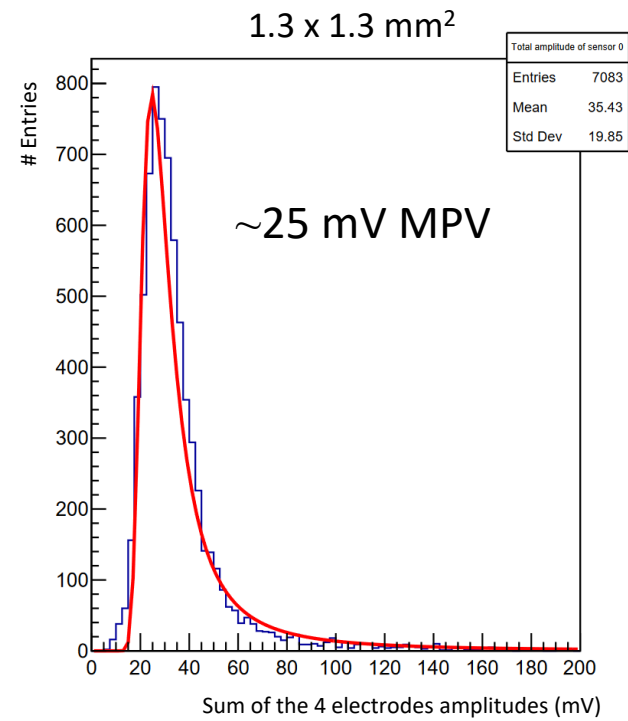
Having a look at the sensors

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The sensors overlap in space and have good signals



All channels of both sensors have low noise ~ 0.8 mV



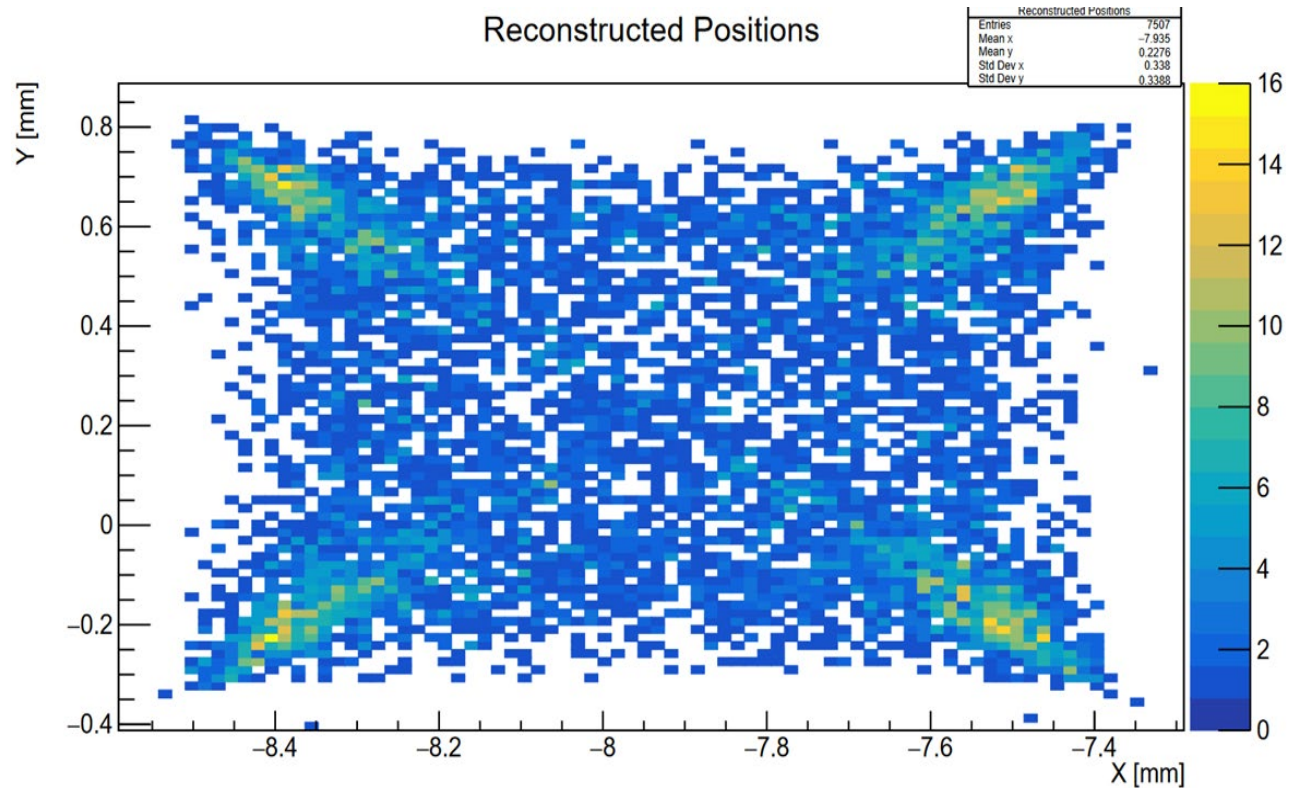
W13 1.3 mm – Position Reconstruction

Firstly, the position was reconstructed with the analytical formula based on the charge (amplitude) imbalance

$$x_{rec,i} = x_{centre} + k_x \frac{pitch}{2} \frac{A_3 + A_4 - (A_1 + A_2)}{\sum_{j=0}^4 A_j}$$

$$y_{rec,i} = y_{centre} + k_y \frac{pitch}{2} \frac{A_1 + A_3 - (A_2 + A_4)}{\sum_{j=0}^4 A_j}$$

The distortion of the reconstructed positions map is typical of this reconstruction method

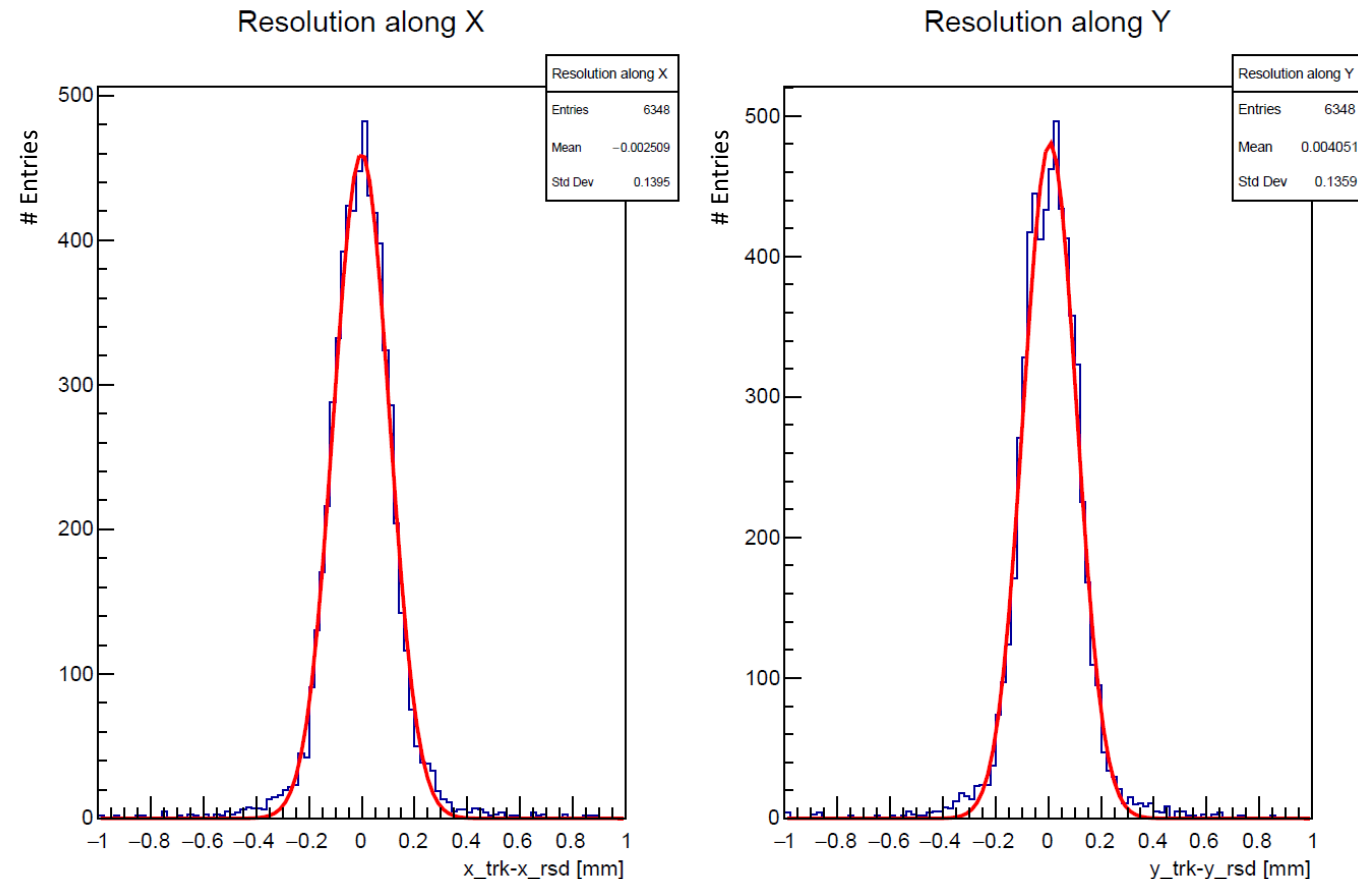


W13 1.3 mm – Position Resolution

About **95 μm** on each axis – 13 % of the pitch.
Better than standard binary pixels (29 %)

As already studied and demonstrated using the data collected with the TCT setup, the resolution can be improved applying a correction (distortion mostly due to the reconstruction method):

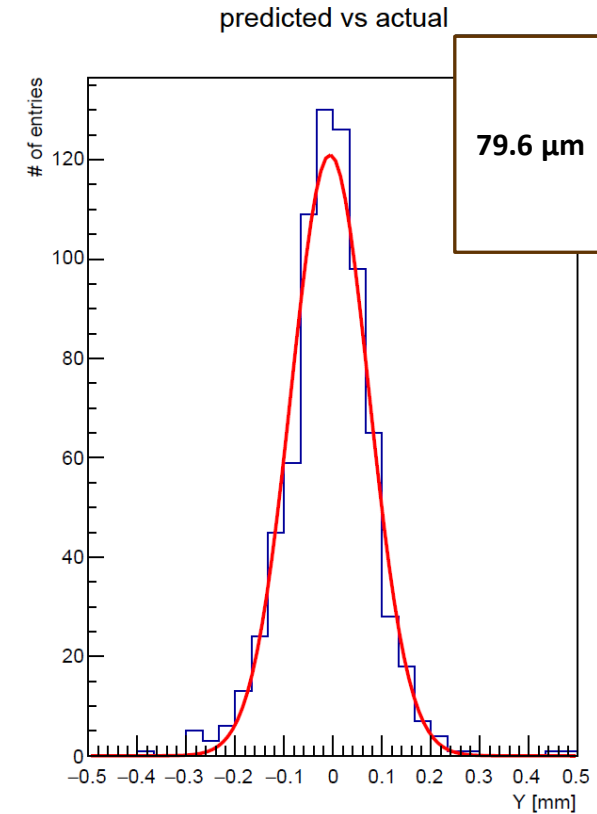
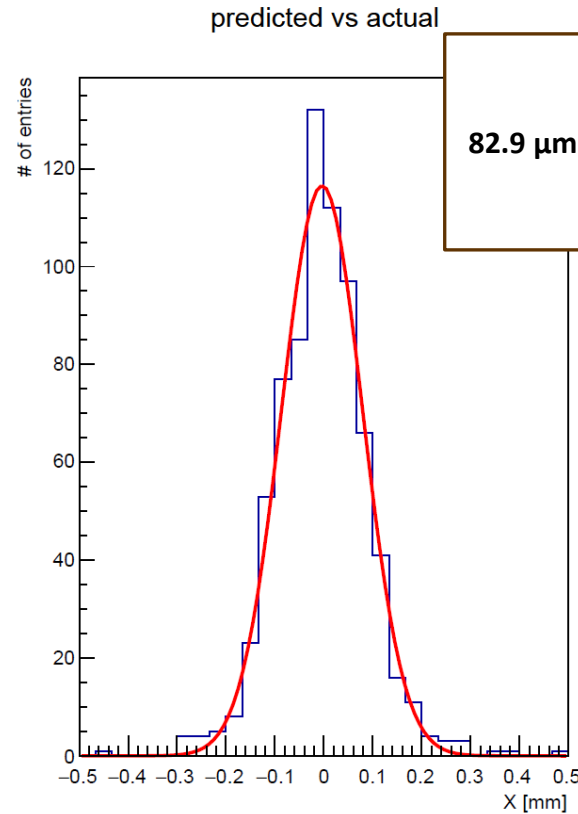
- use of a “migration matrix”
- use of a template to assign the hit position
- use of machine-learning technique



W13 1.3 mm – Machine Learning studies

We tried to implement a Deep Neural Network (presented in the [last TREDI](#))

Although the statistics is very poor for Machine Learning, the results are very promising and present a **15% improvement** compared to the non-corrected results

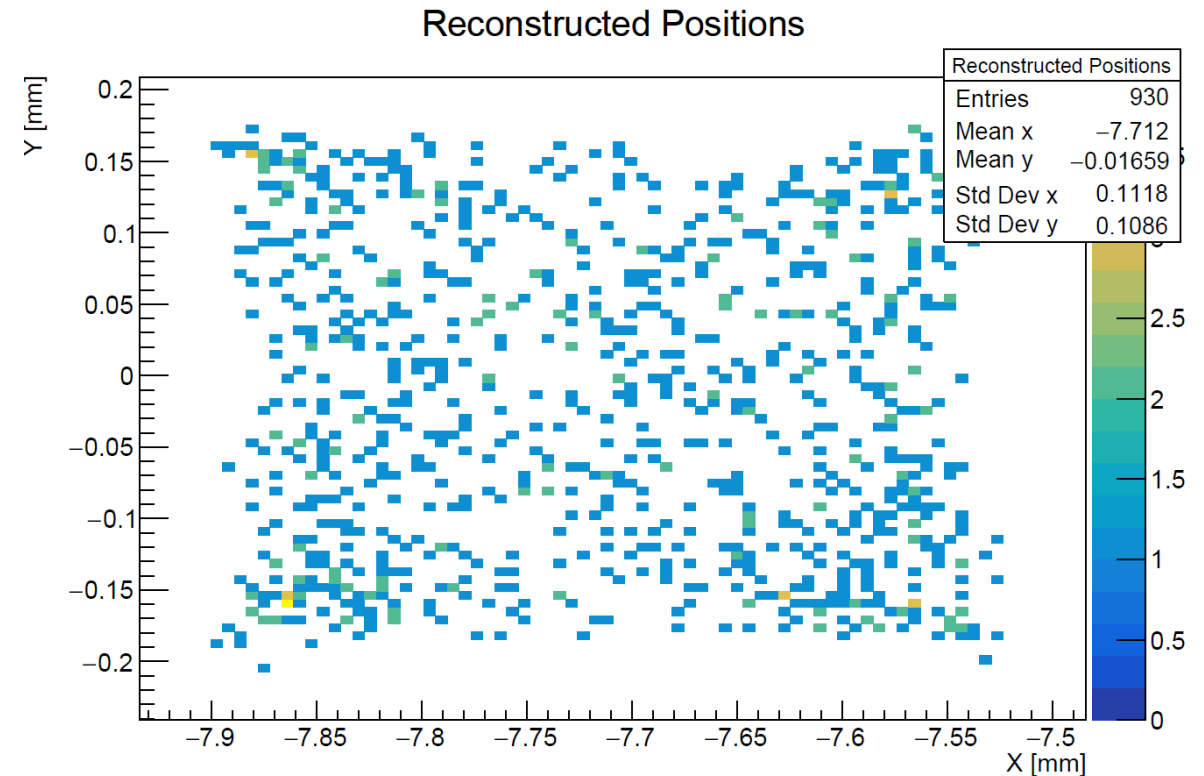


W7 450 μm – Analytical Method

The results of the 450 μm -pitch sensor benefit from the better signal-to-noise ratio

$$x_{rec,i} = x_{centre} + k_x \frac{pitch}{2} \frac{A_3 + A_4 - (A_1 + A_2)}{\sum_{j=0}^4 A_j}$$

$$y_{rec,i} = y_{centre} + k_y \frac{pitch}{2} \frac{A_1 + A_3 - (A_2 + A_4)}{\sum_{j=0}^4 A_j}$$



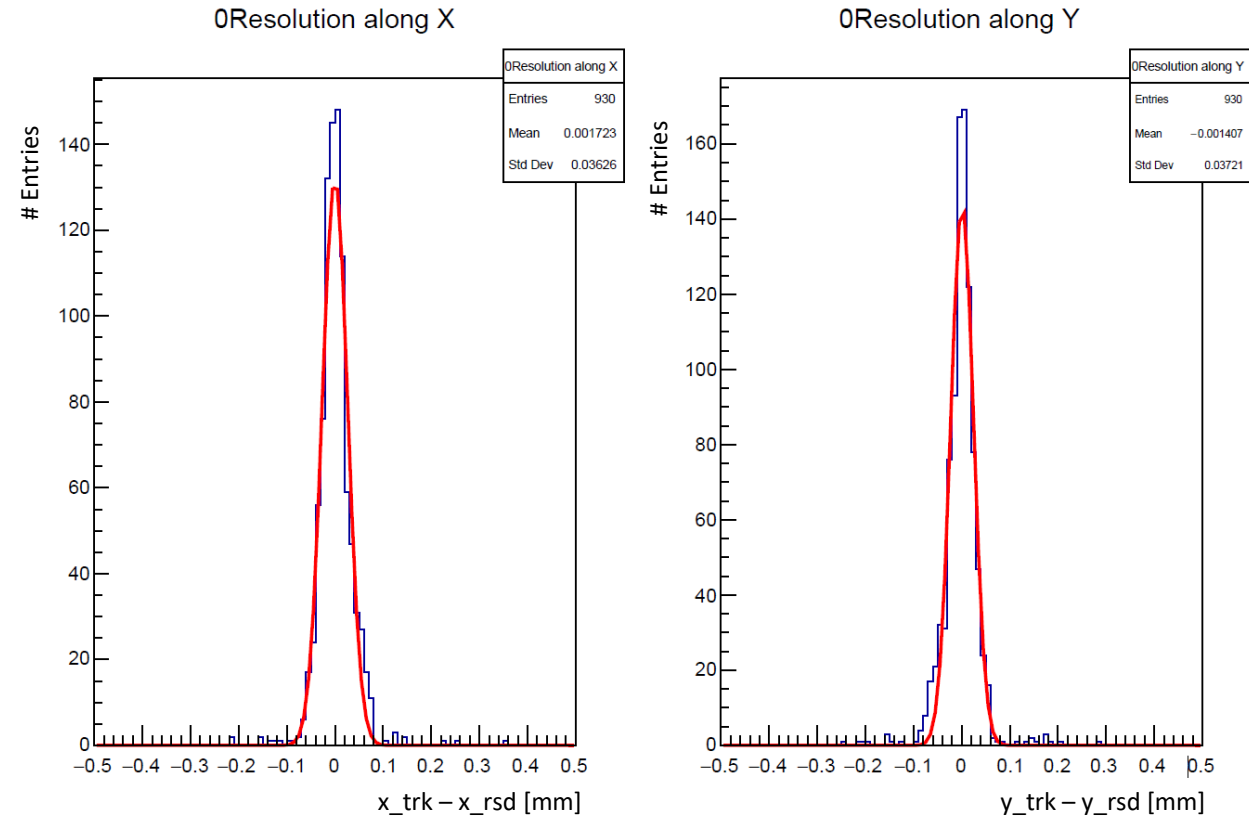
W7 450 μm – Analytical Method

The results of the 450 μm -pitch sensor benefit from the better signal-to-noise ratio

$$x_{rec,i} = x_{centre} + k_x \frac{pitch}{2} \frac{A_3 + A_4 - (A_1 + A_2)}{\sum_{j=0}^4 A_j}$$

$$y_{rec,i} = y_{centre} + k_y \frac{pitch}{2} \frac{A_1 + A_3 - (A_2 + A_4)}{\sum_{j=0}^4 A_j}$$

Reconstruction with the charge imbalance formula leads to a resolution of about 25 μm on each axis
 → 5% of the pitch



W7 450 um – Template Method

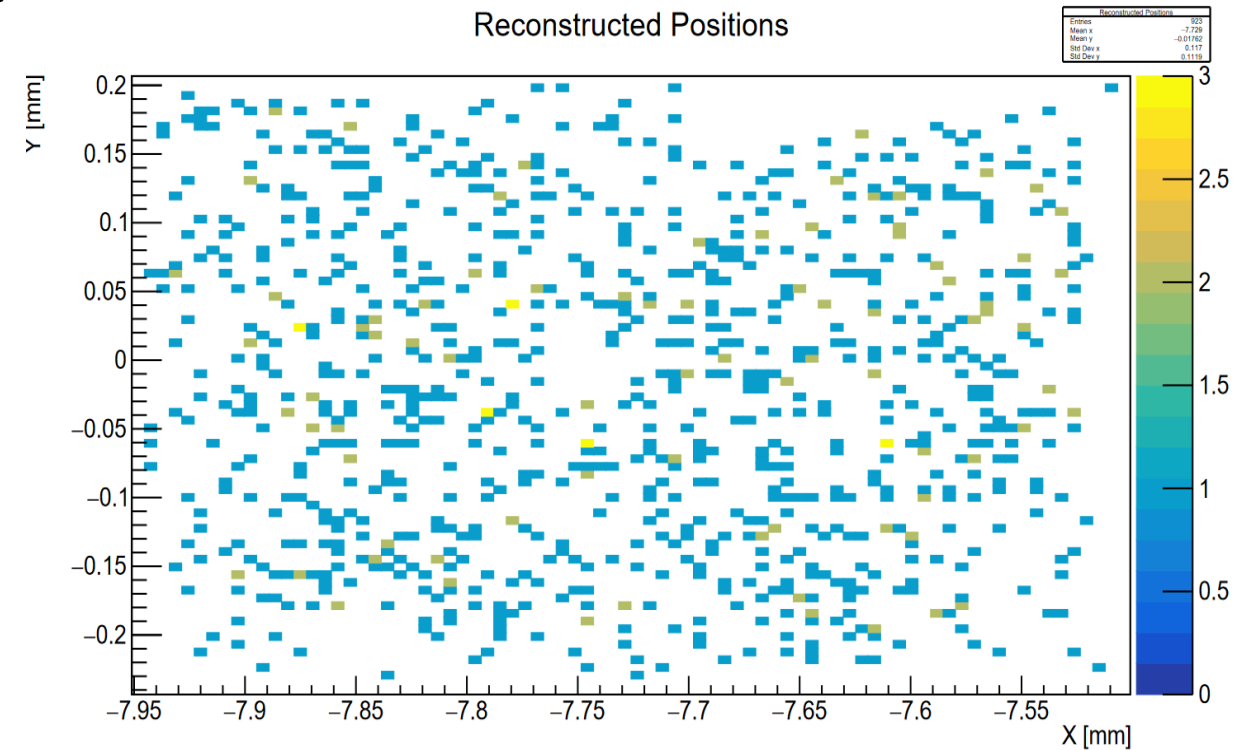
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Positions were also reconstructed using the “**template method**”.

The hit position is extracted starting from the amplitudes read out by the four electrodes, using the template computed with the test beam data @DESY (see Nicolò’s talk)

The template was computed using the same sensor type, but different **sensor die**, **n+ resistivity**, and **electronics**

The template works well!
No position distortion pattern is visible

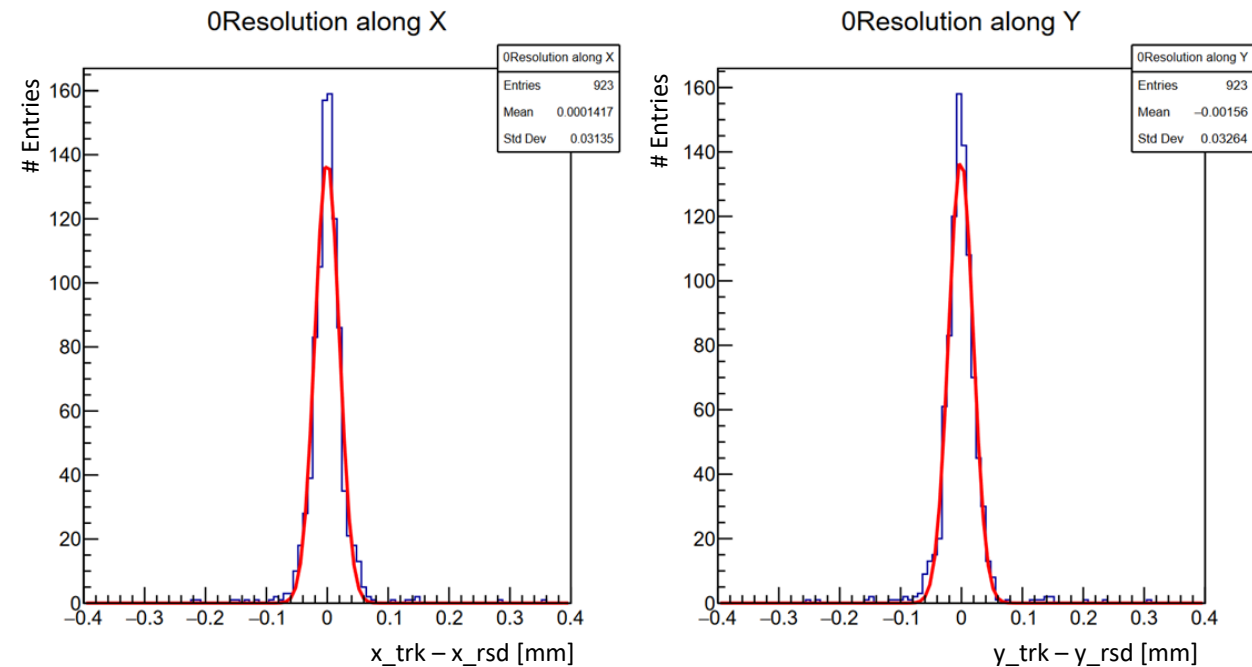


W7 450 μm – Template Method

Secondly, positions were reconstructed thanks to a **template method**.

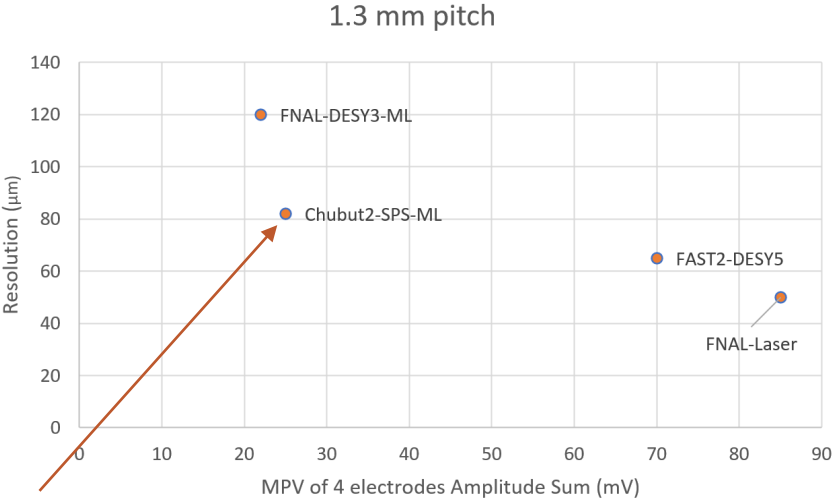
About **20 μm** on each axis with the template reconstruction (19.5 μm) – **4% of the pitch**

The reconstruction with the template computed in a different experimental setup is viable



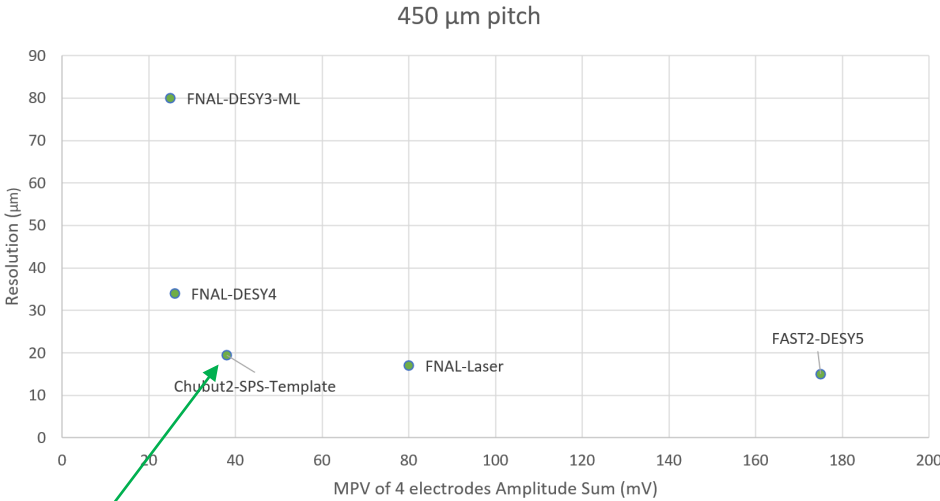
Comparison with other test beams

Comparing with the best results achieved in other test beams



Suffering from low signals and low statistics. It would benefit from a dedicated template/Machine Learning training dataset

Good results with low signals



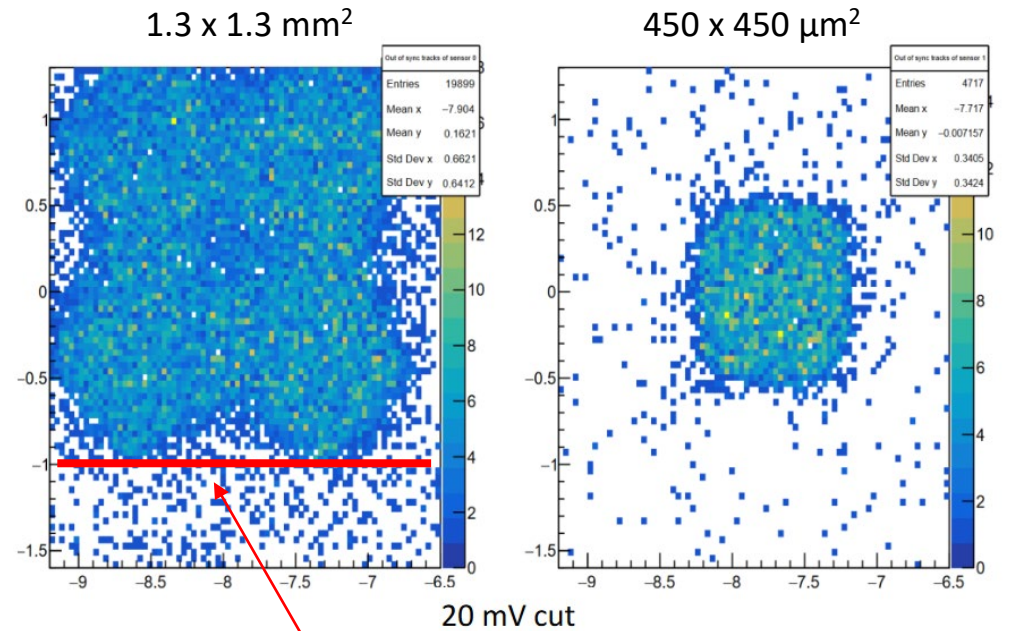
Performance is very good thanks to the template model created on another test beam facility and on another electronics!

Very good results with low signals

Efficiency

We defined a hit on a sensor as the combination of three conditions

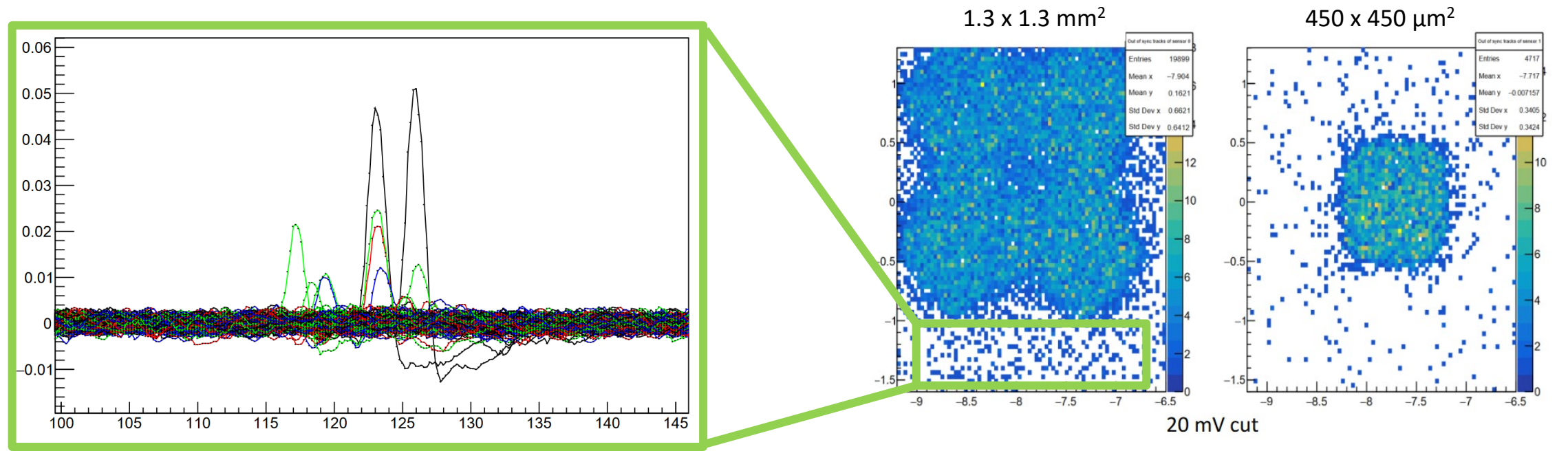
- *time*: the RSD hit timestamp must be compatible with the tracks in the tracker
- *amplitude*: sum of the four signals amplitudes must be above a certain threshold ($\sim 3x$ sigma noise)
- *track*: there is a reconstructed track pointing inside the sensor area
 - **But** some tracks are reconstructed in the wrong positions!



The silicon physically ends here

Efficiency

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Efficiency

Because of the tracks small mis-reconstruction, one has to use the signals on one of the two sensors to infer the efficiency of the other

→ only the efficiency of the smaller sensor can be computed

$$Eff_{450\mu m} = \frac{\#tracks(hit_{450\mu m} \wedge hit_{1.3mm})}{\#tracks(track_{450\mu m} \wedge hit_{1.3mm})}$$

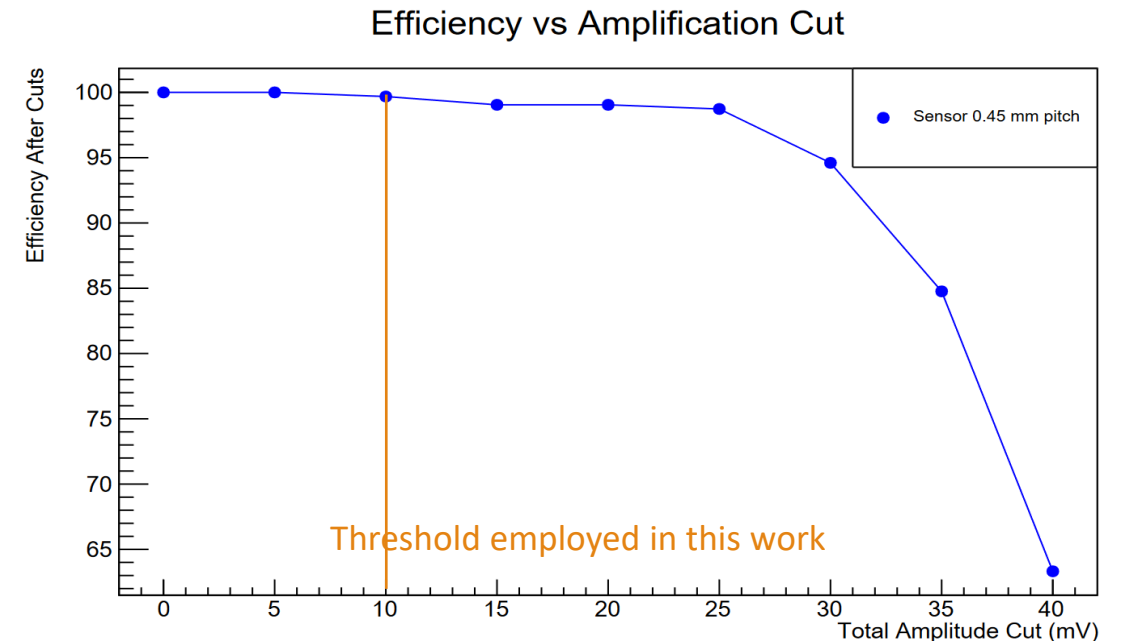
Efficiency

Because of the tracks small mis-reconstruction, one has to use the signals on one of the two sensors to infer the efficiency of the other

→ only the efficiency of the smaller sensor can be computed (completely inside the bigger one)

$$Eff_{450\mu m} = \frac{\#tracks(hit_{450\mu m} \wedge hit_{1.3mm})}{\#tracks(track_{450\mu m} \wedge hit_{1.3mm})}$$

Values of efficiency typical of silicon are maintained, > **99%**



Conclusions

The performance of two RSD2 sensors, 1.3mm pitch and 450 μm pitch, were measured during the second AIDAInnova 2023 test beam at SPS.

The devices were bonded to a novel low-noise and open-source electronics: the Chubut2 board

The best spatial resolutions achieved are:

1. $\sigma_{1.3 \text{ mm}} \sim \mathbf{81 \mu\text{m}}$ employing a Machine Learning approach (6% of the pitch)
2. $\sigma_{450 \mu\text{m}} \sim \mathbf{19.5 \mu\text{m}}$ with the template method (4.3% of the pitch)

Both designs achieve significantly better results than those of standard pixel detectors (15-30%) with a low number of channels.

The detection efficiency of a 450 μm pitch RSD2 was evaluated to be **>99%**

AIDAinnova WP6 Test Beam group

- ❑ CNM-Barcelona (AIDAinnova): Oscar David Ferrer Naval
- ❑ IFCA (AIDAinnova + ETL): Ivan Vila Alvarez, Andres Molina
- ❑ Ribagorda, Jordi Duarte Campderros, Efren Navarrete Ramos,
- ❑ Marcos Fernandez Garcia, Ruben Lopez Ruiz
- ❑ IJS (AIDAinnova): Gregor Kramberger, Jernej Debevc
- ❑ The UFSD group (University of Torino / INFN): Roberta Arcidiacono, Nicolò Cartiglia, Marco Ferrero, Leonardo Lanteri, Luca Menzio, Roberto Mulargia, Federico Siviero, Valentina Sola
- ❑ INFN Genova: Claudia Gemme
- ❑ UZH (AIDAinnova): Anna Macchiolo, Matias Senger
- ❑ Korea: D. Lee, W. Jun, T. Kim
- ❑ CERN: A. Rummler, V. Gkougkousis

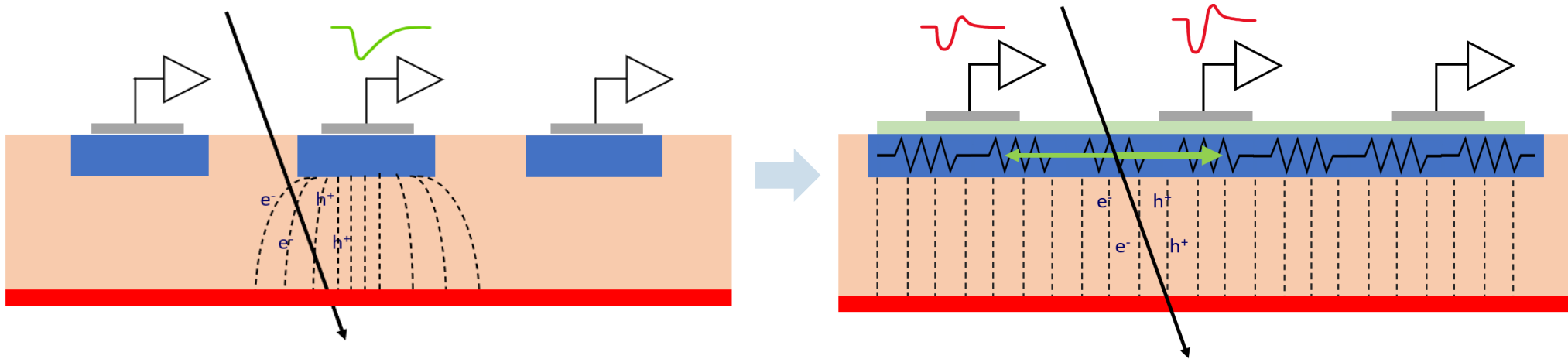
Acknowledgements

We kindly acknowledge the following funding agencies and collaborations

- This project has received funding from the European Union's Horizon 2020 Research and Innovation programme under Grant Agreement No 101004761
- INFN - Gruppo V, UFSD and RSD projects
- INFN – FBK agreement on sensor production (convenzione INFN-FBK)
- Horizon 2020, grant UFSD66952
- Dipartimenti di Eccellenza, Univ. of Torino (ex L. 232/2016, art. 1, cc. 314, 337)
- Ministero della Ricerca, Italia , PRIN 2017, progetto 2017L2XKTJ – 4DinSiDe
- Ministero della Ricerca, Italia, FARE, R165xr8ftr_fare

Resistive Read-out

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- In resistive read-out, instead of many p-n diodes, there is a single diode.
- The n-doped implant is resistive and acts as a signal divider
- Very uniform electric and weighing fields, perfect geometry for timing

Runs

Two test beam performed: June and August

Practically, only August has good runs (Mimosa problems, not much time for RSDs runs)

41	Data run, EVERYTHING LOOKS GOOD 🌈 🌈 🌈	87470
42	Data run, EVERYTHING LOOKS GOOD 🌈 🌈 🌈	273174
43	Data run, EVERYTHING LOOKS GOOD 🌈 🌈 🌈	27989
44	Data run, EVERYTHING LOOKS GOOD 🌈 🌈 🌈 CAENGECO2020.log	127551
50	Data run, EVERYTHING LOOKS GOOD 🌈 🌈 🌈	
51	🌈 🌈 🌈	409414
52	🌈 🌈 🌈	39820

With trigger signals
But corrupted 6th
mimosa plane

4 sensors:

- W13 1.3 mm-pitch
- 2x W7 450 um-pitch
- W3 450 um (low bias due to high current)

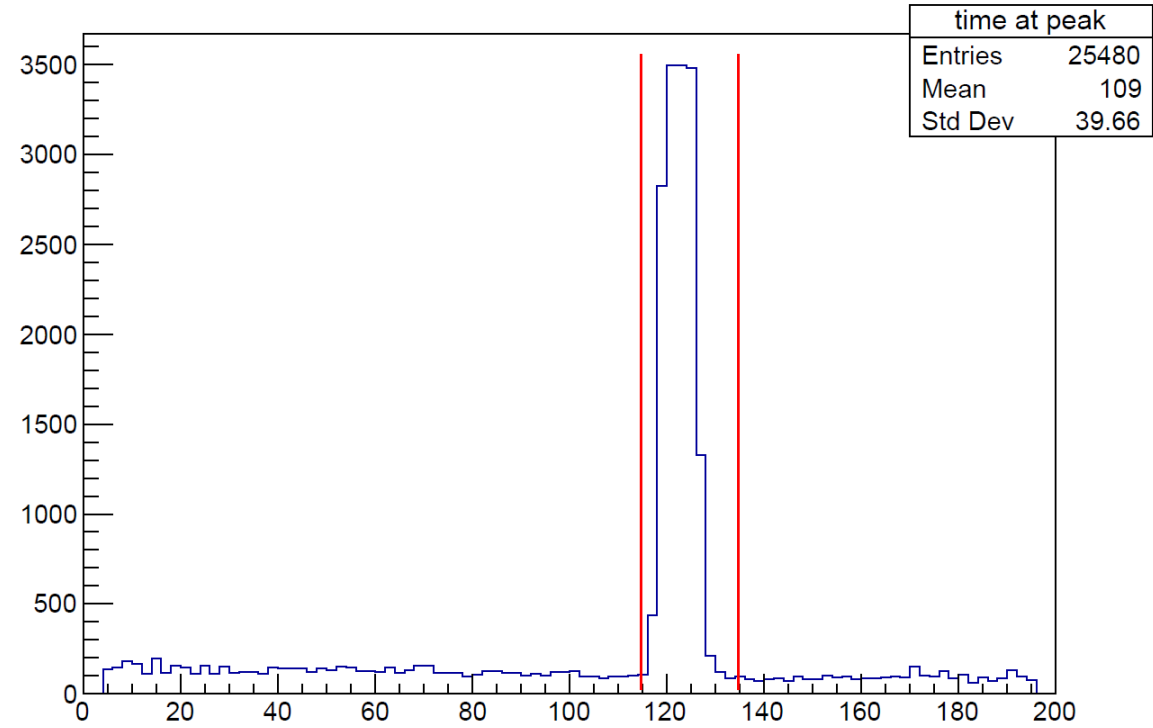
2-3 bias points per sensor

Given the nature of the readout board, 4 electrodes were read.

The analysis is restricted to one pixel of the matrix

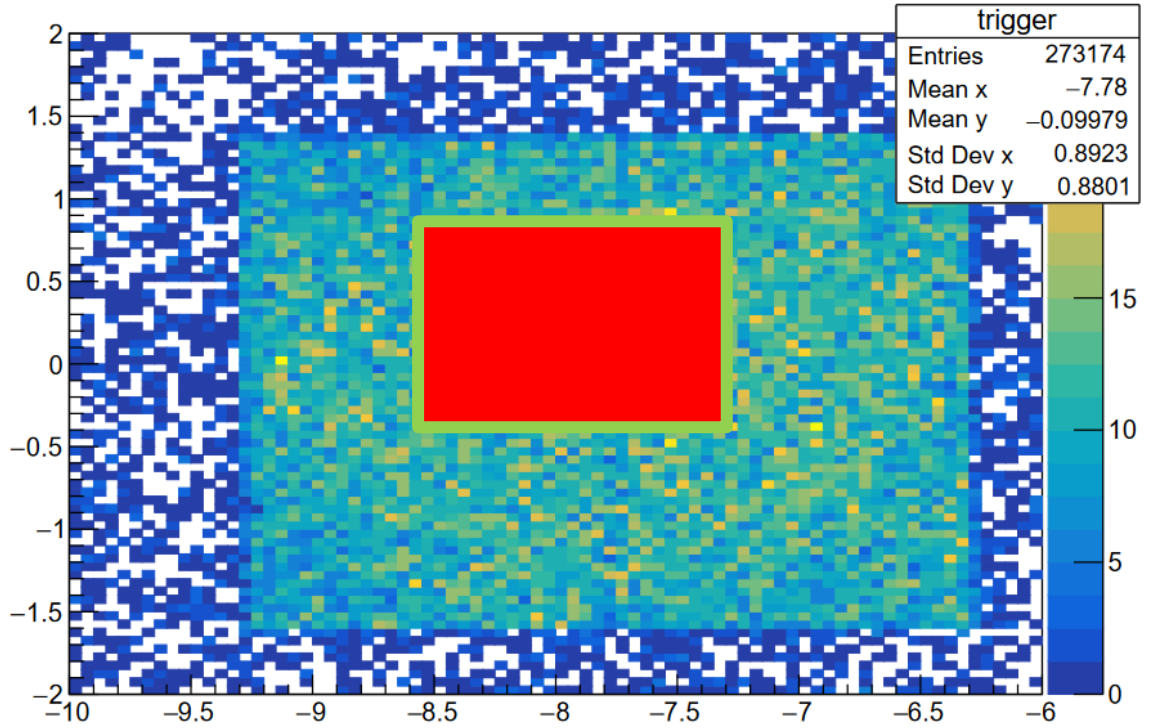
Cuts

time at peak



1) Tracks within time window

trigger

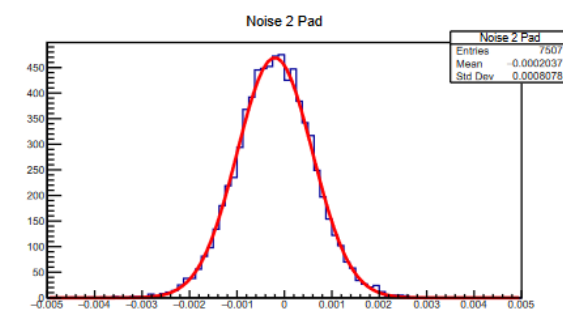
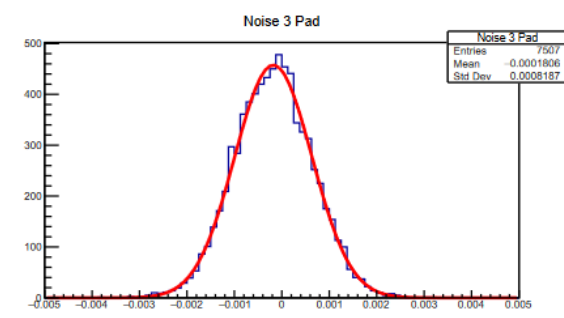
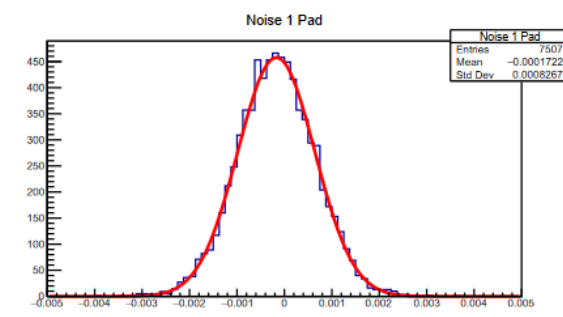
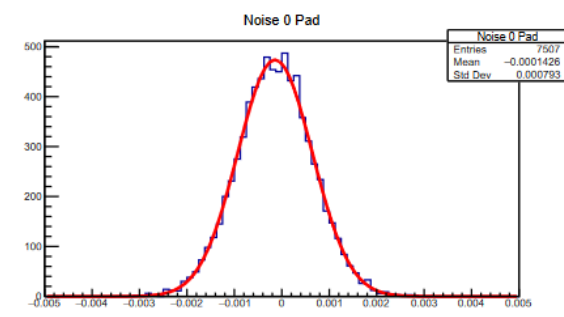
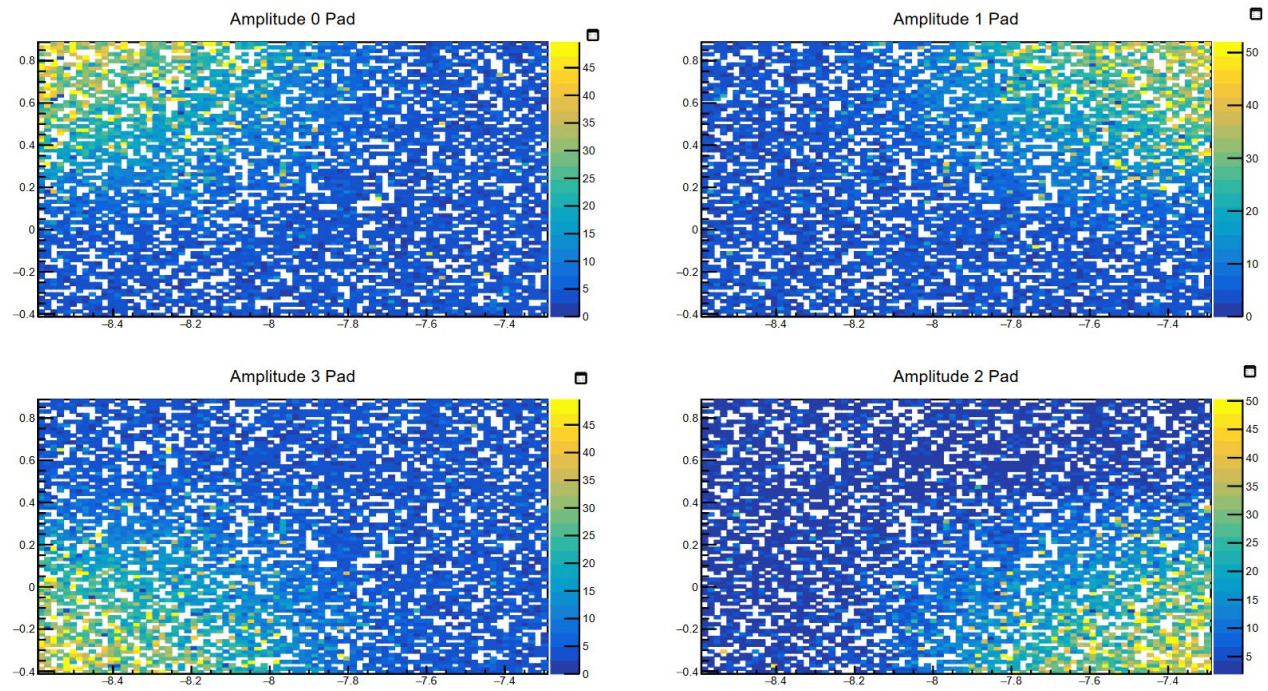


2) Tracks inside the pixel

First sensor - W13 1.3mm

Quite small MPV for the amplitude (as expected) 30 mV

Very low noise <1 mV



S/N for the single pad is good

Taking a look at the data

1. **W13 1.3 mm** has smaller signals
 - Although not ideal, it can be used for the reconstruction (rotated by 2.5 degrees)
2. The data from the **first 450 um W7** is good (rotated by 1.7 degrees)
 - High-enough signals and
 - Another data acquisition was performed in DESY with a similar sensor
3. The second **450 um W7** has really small signals, even if the bias is almost the same as the first sensor
4. The fourth sensor (**450 um W3**) had issues and its signals are very low cannot be used for reconstruction



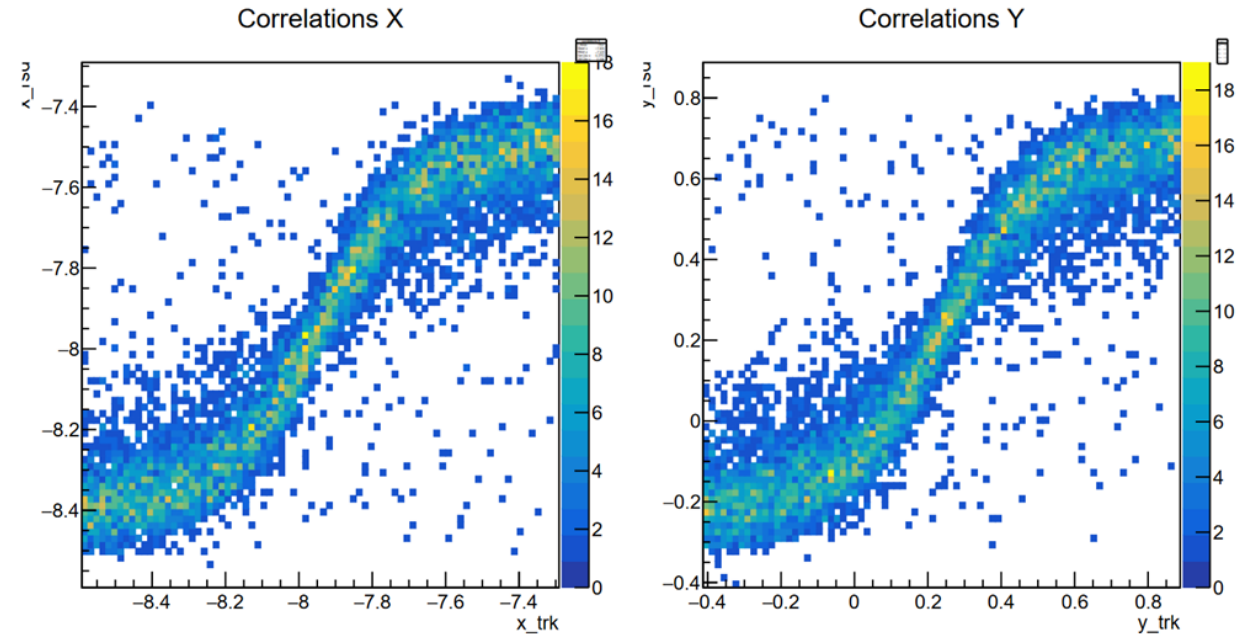
Taken into consideration in this work

W13 1.3 mm – Position Reconstruction

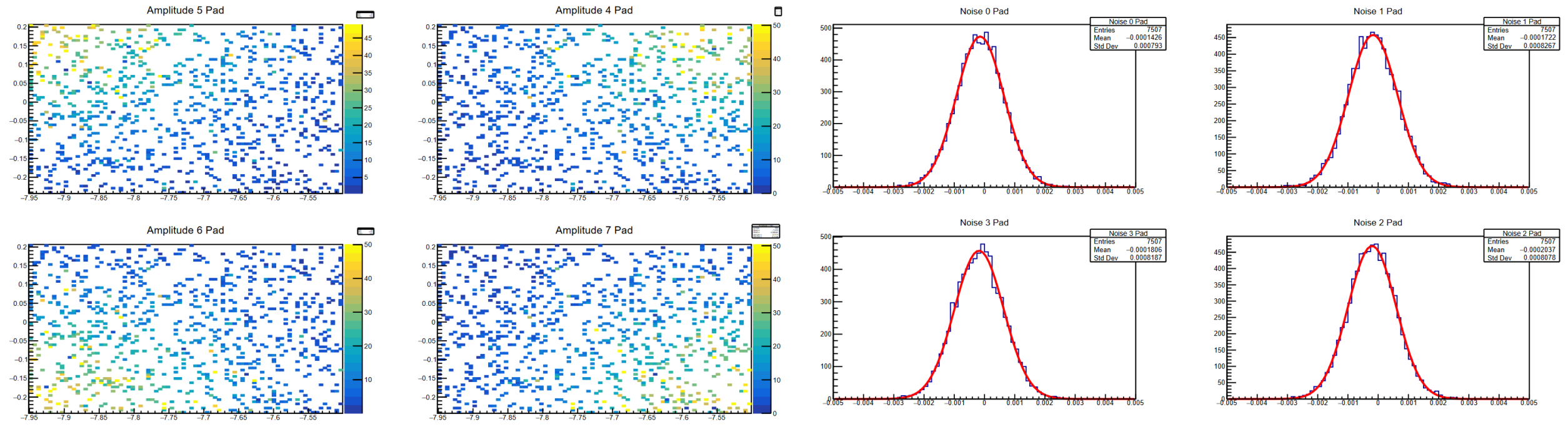
Reconstruction with charge imbalance

$$x_{rec,i} = x_{centre} + k_x \frac{pitch}{2} \frac{A_3 + A_4 - (A_1 + A_2)}{\sum_{j=0}^4 A_j}$$

$$y_{rec,i} = y_{centre} + k_y \frac{pitch}{2} \frac{A_1 + A_3 - (A_2 + A_4)}{\sum_{j=0}^4 A_j}$$



W7 450 um

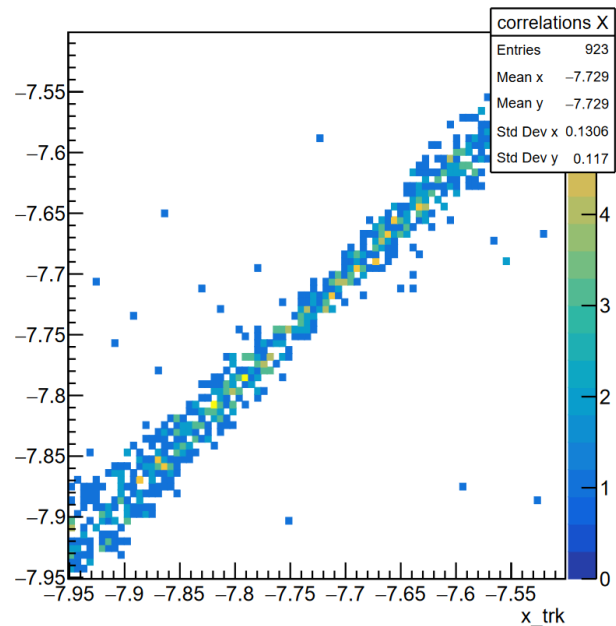


Same as before, slightly better S/N

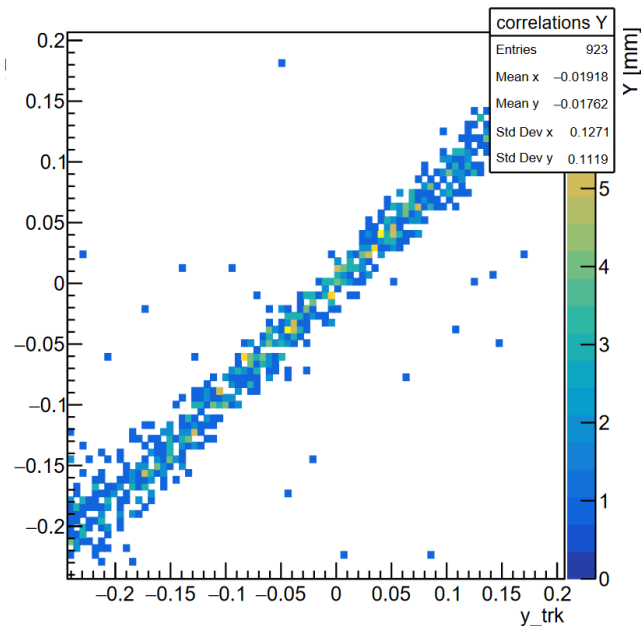
W7 450 um

Secondly, positions were reconstructed thanks to the information gathered at another test beam in DESY with a similar sensor. SPS positions are extracted by comparing the pads amplitudes with the ones registered in the DESY data (template)

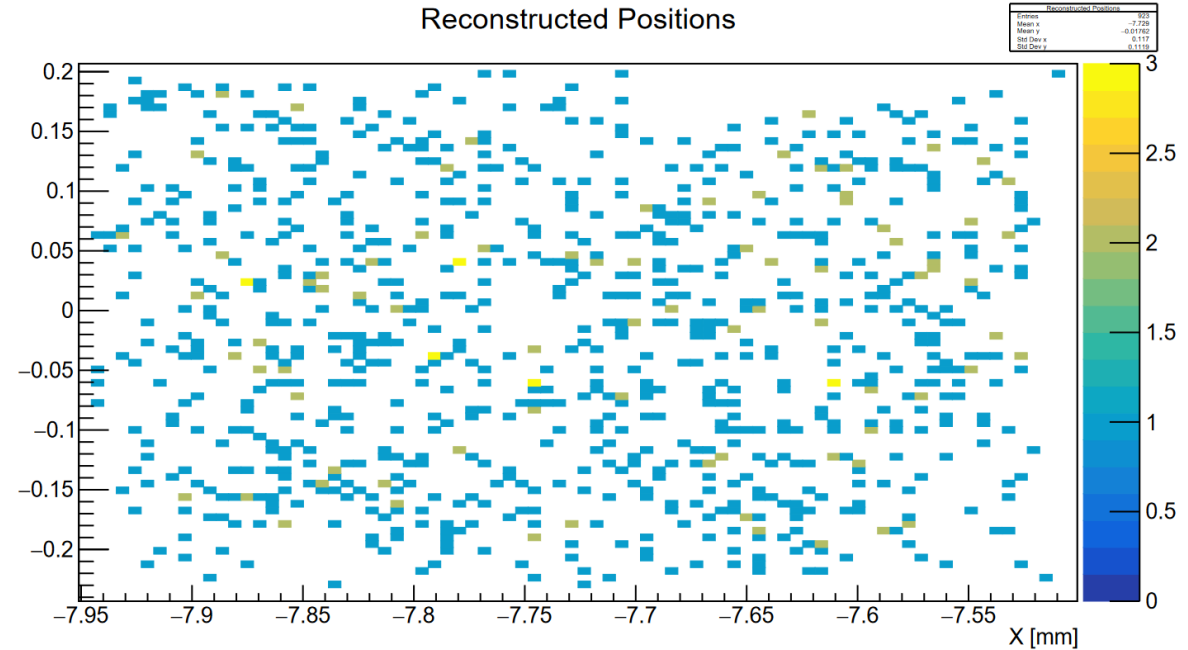
Correlations X



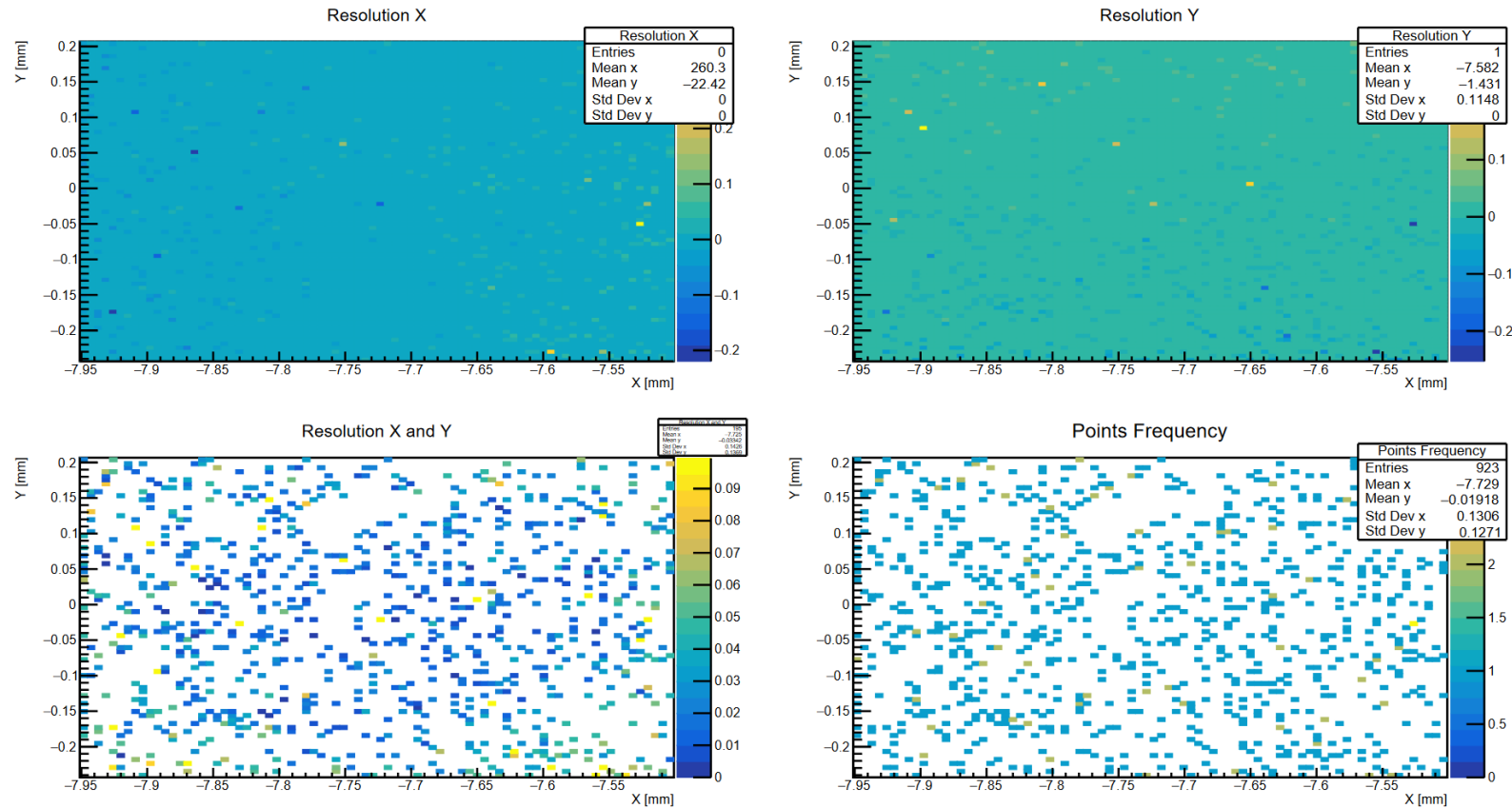
Correlations Y



Reconstructed Positions



W7 450 um – first plane

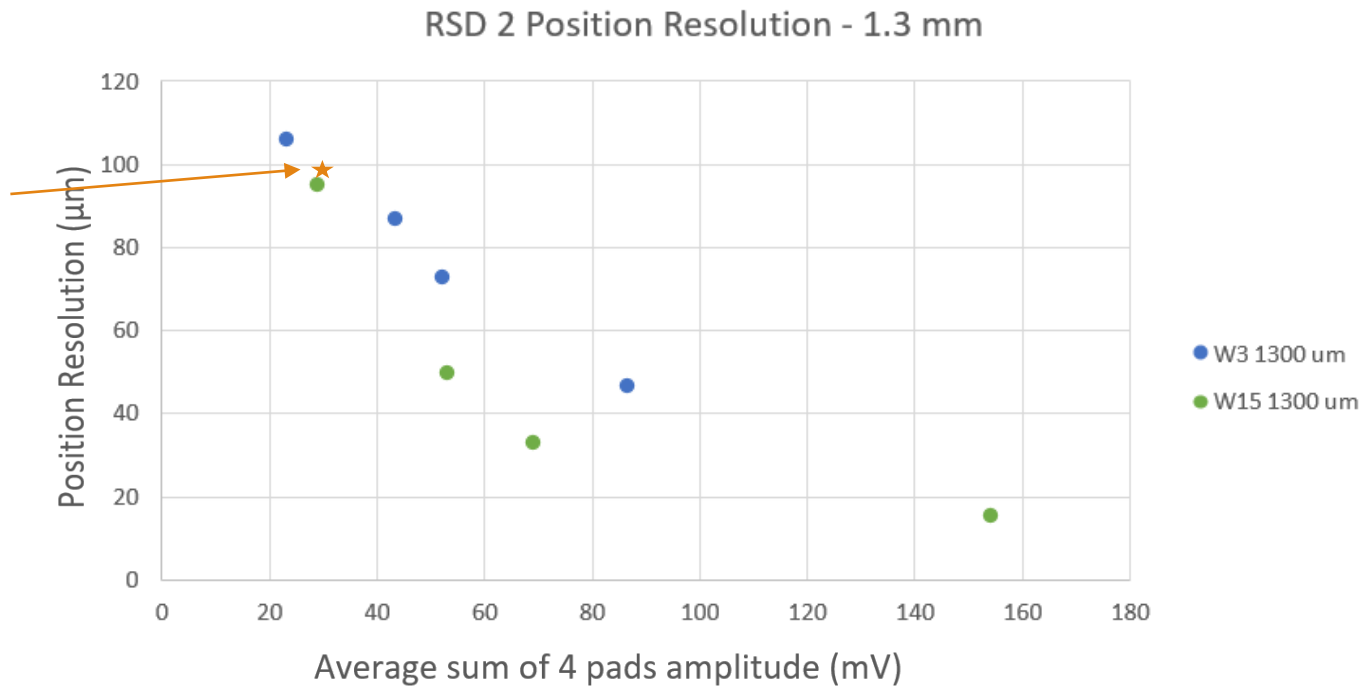


Resolution is uniform over the whole pixel

Comparison with TCT – 1.3 mm

TCT data was corrected, but the results are still comparable

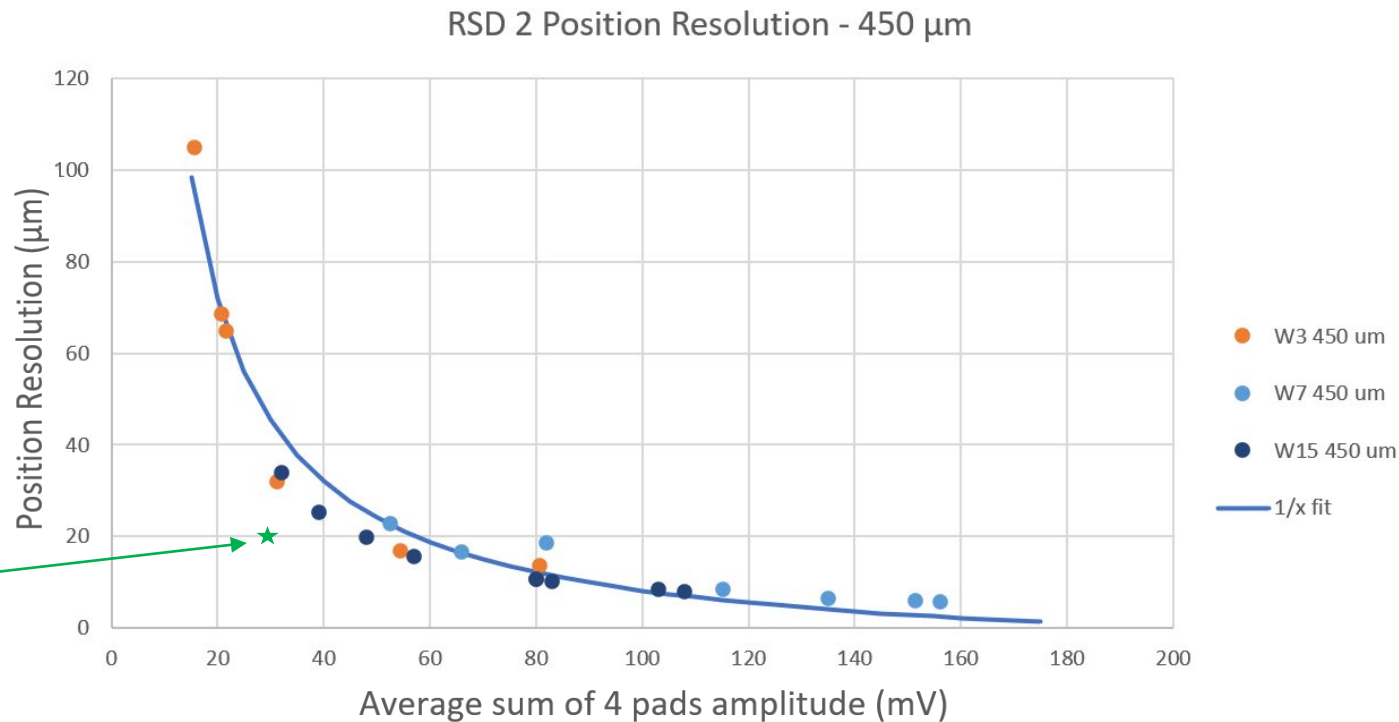
This analysis



For sake of completeness, the S/N ratio is different and this point should be further on the right. A correction is needed

Comparison with TCT – 450 μm

TCT data was corrected, but the results are still comparable



The difference is more visible in this plot

This analysis

RSD2 Gain

RSD2 Gain on FNAL vs PiN on Mignone + 40 dB

